

HAT2071R

Silicon N Channel Power MOS FET Power Switching

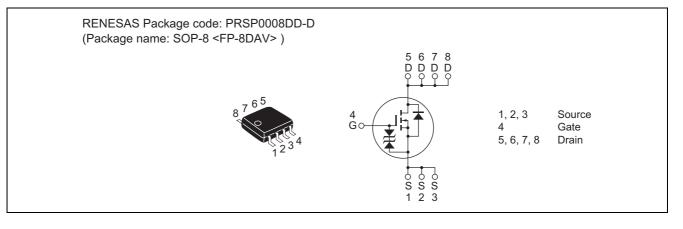
REJ03G1178-0400 (Previous: ADE-208-1227B) Rev.4.00 Sep 07, 2005

Features

- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance

 $R_{DS (on)} = 16 \text{ m}\Omega \text{ typ} (at V_{GS} = 10 \text{ V})$

Outline





Absolute Maximum Ratings

			(Ta = 25°C)
Item	Symbol	Value	Unit
Drain to source voltage	V _{DSS}	30	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	10	А
Drain peak current	I _{D (pulse)} Note 1	80	А
Body-drain diode reverse drain current	I _{DR}	10	А
Channel dissipation	Pch Note 2	2.5	W
Channel to ambient thermal impedance	θ ch-a ^{Note 2}	50	°C/W
Channel temperature	Tch	150	٥°
Storage temperature	Tstg	-55 to +150	٥°
	. e.g		•

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

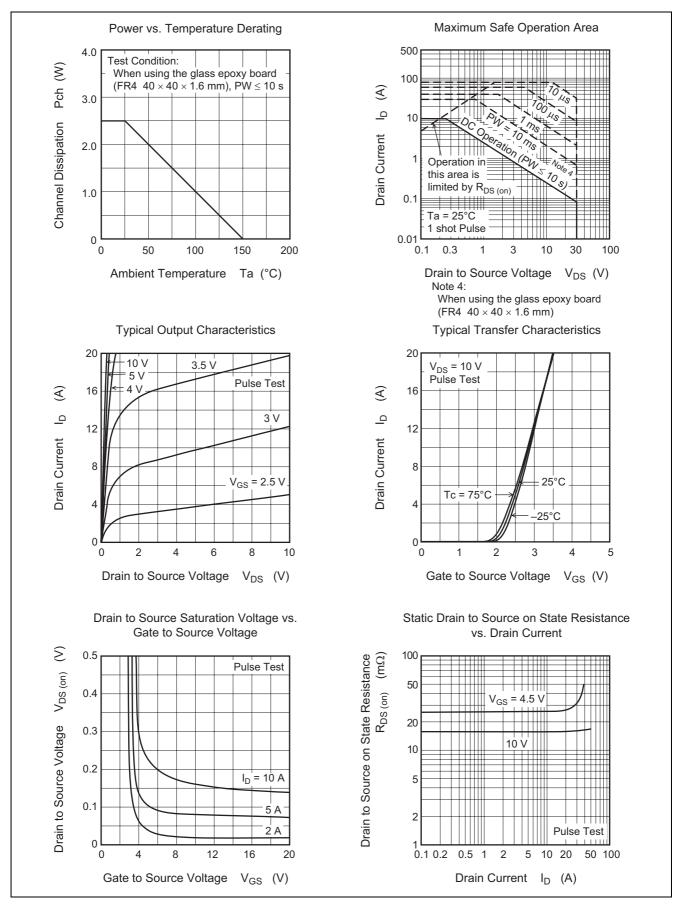
2. When using the glass epoxy board (FR4 40 \times 40 \times 1.6 mm), PW \leq 10 s

Electrical Characteristics

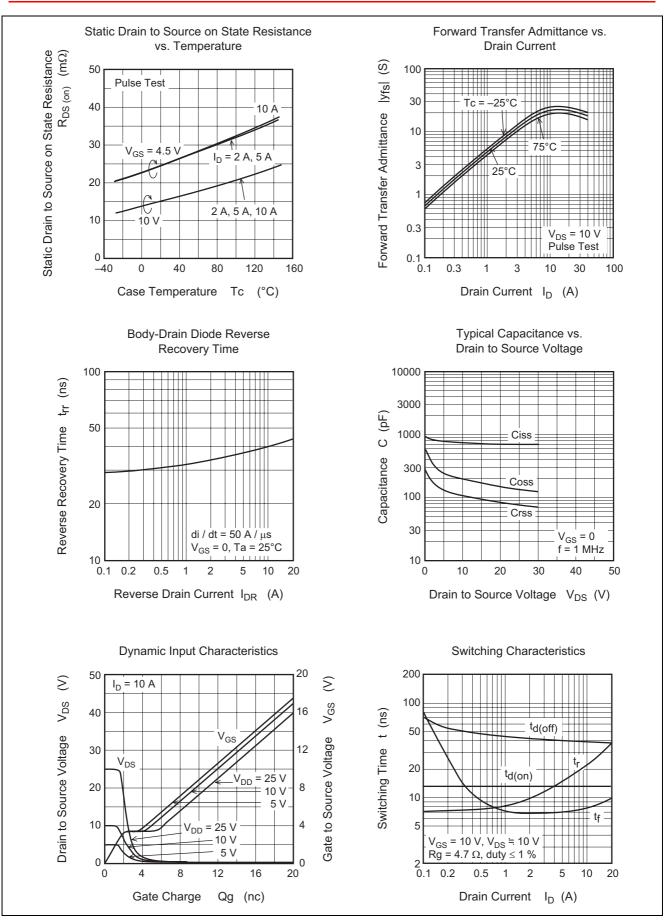
						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V (BR) DSS	30			V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V (BR) GSS	±20	—		V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	—	—	±10	μA	$V_{GS} = \pm 16 \text{ V}, \text{ V}_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	—	_	1	μA	$V_{DS} = 30 V, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS (off)}	1.0	_	2.5	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$
Static drain to source on state resistance	R _{DS (on)}	—	16	20	mΩ	$I_D = 5 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note 3}}$
	R _{DS (on)}	—	25	36	mΩ	$I_D = 5 \text{ A}, V_{GS} = 4.5 \text{ V}^{Note 3}$
Forward transfer admittance	y _{fs}	10	16		S	$I_D = 5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note 3}}$
Input capacitance	Ciss	—	740	_	pF	V _{DS} = 10 V
Output capacitance	Coss	—	200	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	110		pF	f = 1 MHz
Total gate charge	Qg	—	12		nC	V _{DD} = 10 V
Gate to source charge	Qgs	—	2.3		nC	V _{GS} = 10 V
Gate to drain charge	Qgd	—	2.2		nC	I _D = 10 A
Turn-on delay time	t _{d (on)}	—	13		ns	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$
Rise time	tr	—	15		ns	$V_{DD}\cong 10~V$
Turn-off delay time	t _{d (off)}	—	40		ns	$R_L = 2 \Omega$
Fall time	t _f	_	7		ns	Rg = 4.7 Ω
Body-drain diode forward voltage	V _{DF}	—	0.85	1.10	V	$I_F = 10 \text{ A}, V_{GS} = 0^{\text{Note 3}}$
Body-drain diode reverse recovery time	t _{rr}	_	40		ns	$I_F = 10 \text{ A}, V_{GS} = 0$
						di _F /dt = 50 A/µs

Note: 3. Pulse test

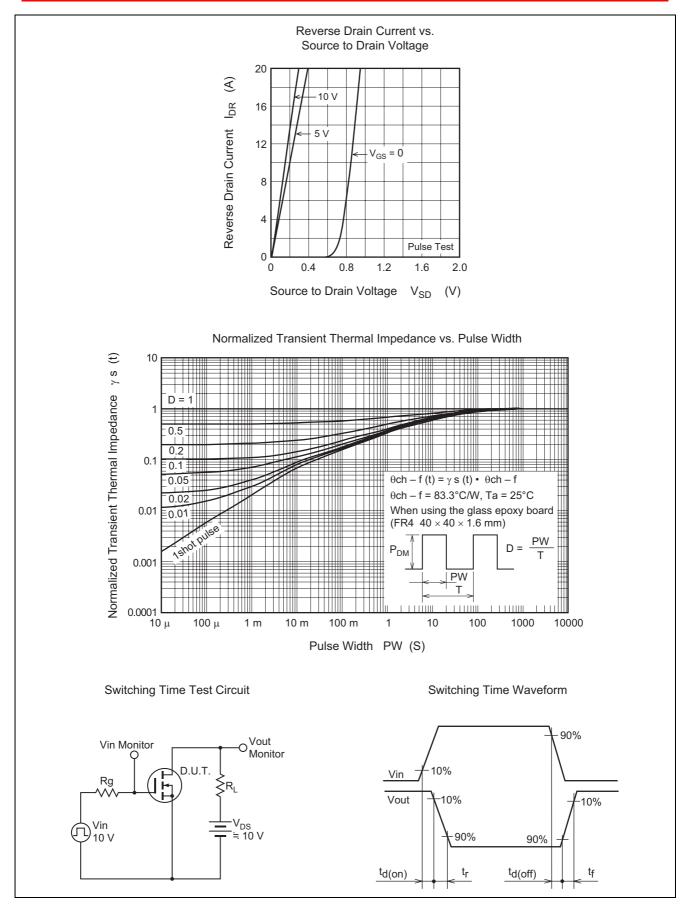
Main Characteristics





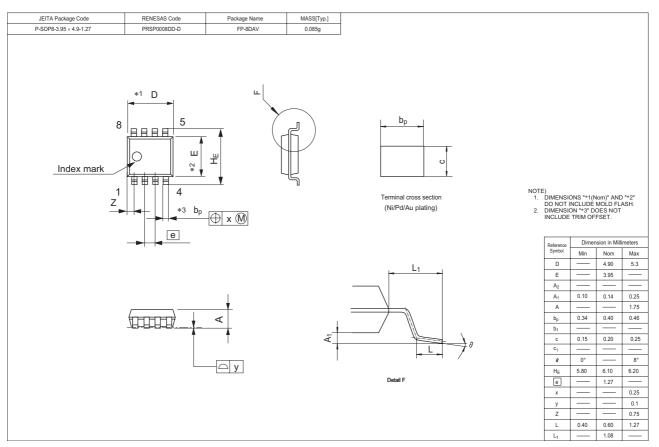


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Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2071R-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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